

## Features

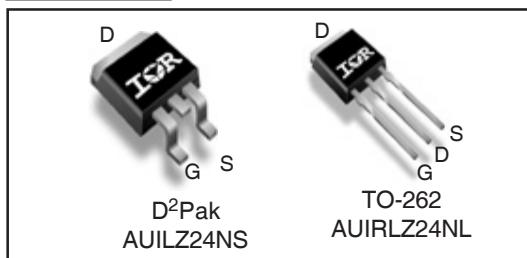
- Advanced Process Technology
- Logic Level Gate Drive
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to T<sub>jmax</sub>
- Lead-Free, RoHS Compliant
- Automotive Qualified \*

## Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

## HEXFET® Power MOSFET

<b>V<sub>DSS</sub></b>	<b>55V</b>
<b>R<sub>DS(on)</sub> max.</b>	<b>0.06Ω</b>
<b>I<sub>D</sub></b>	<b>18A</b>



## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T<sub>A</sub>) is 25°C, unless otherwise specified.

Parameter	Standard Pack		Orderable Part Number
	Form	Quantity	
AUIRLZ24NS	D2-Pak	Tube	50
		Tape and Reel Left	800
AUIRLZ24NL	TO-262	Tube	50

## Thermal Resistance

Parameter	Typ.	Max.	Units
R <sub>θJC</sub>	Junction-to-Case	—	—
R <sub>θJA</sub>		3.3	°C/W

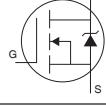
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\*Qualification standards can be found at <http://www.irf.com/>

### Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	55	—	—	V	$V_{GS} = 0V$ , $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.061	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$ ⑤
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.060	$\Omega$	$V_{GS} = 10V$ , $I_D = 11\text{A}$ ④
		—	—	0.075		$V_{GS} = 5.0V$ , $I_D = 11\text{A}$ ④
		—	—	0.105		$V_{GS} = 4.0V$ , $I_D = 9.0\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	1.0	—	2.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$
$g_f$	Forward Transconductance	8.3	—	—	S	$V_{DS} = 25V$ , $I_D = 11\text{A}$ ⑤
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	25	$\mu\text{A}$	$V_{DS} = 55V$ , $V_{GS} = 0V$
		—	—	250		$V_{DS} = 44V$ , $V_{GS} = 0V$ , $T_J = 150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	$\text{nA}$	$V_{GS} = 16V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -16V$
$Q_g$	Total Gate Charge	—	—	15	$\text{nC}$	$I_D = 11\text{A}$
$Q_{gs}$	Gate-to-Source Charge	—	—	3.7		$V_{DS} = 44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	—	8.5		$V_{GS} = 5.0V$ , See Fig. 6 and 13 ④⑤
$t_{d(on)}$	Turn-On Delay Time	—	7.1	—	$\text{ns}$	$V_{DD} = 28V$
$t_r$	Rise Time	—	74	—		$I_D = 11\text{A}$
$t_{d(off)}$	Turn-Off Delay Time	—	20	—		$R_G = 12\Omega$ , $V_{GS} = 5.0V$
$t_f$	Fall Time	—	29	—		$R_D = 2.4\Omega$ , See Fig. 10 ④⑤
$L_S$	Internal Source Inductance	—	7.5	—	nH	Between lead, and center of die contact
$C_{iss}$	Input Capacitance	—	480	—	$\text{pF}$	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	130	—		$V_{DS} = 25V$
$C_{rss}$	Reverse Transfer Capacitance	—	61	—		$f = 1.0\text{MHz}$ , See Fig. 5⑤

### Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	18	A	MOSFET symbol showing the integral reverse p-n junction diode.
$I_{SM}$	Pulsed Source Current (Body Diode) ①	—	—	72		
$V_{SD}$	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}$ , $I_S = 11\text{A}$ , $V_{GS} = 0V$ ④
$t_{rr}$	Reverse Recovery Time	—	60	90	ns	$T_J = 25^\circ\text{C}$ , $I_F = 11\text{A}$
$Q_{rr}$	Reverse Recovery Charge	—	130	200	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ④⑤
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

#### Notes

① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )

②  $V_{DD} = 25V$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 790\mu\text{H}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 11\text{A}$ . (See Figure 12)

③  $I_{SD} \leq 11\text{A}$ ,  $di/dt \leq 290\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(\text{BR})\text{DSS}}$ ,  $T_J \leq 175^\circ\text{C}$

④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

⑤ Uses IRLZ24N data and test conditions.

\*\* When mounted on 1" square PCB ( FR-4 or G-10 Material ).

For recommended footprint and soldering techniques refer to application note #AN-994.

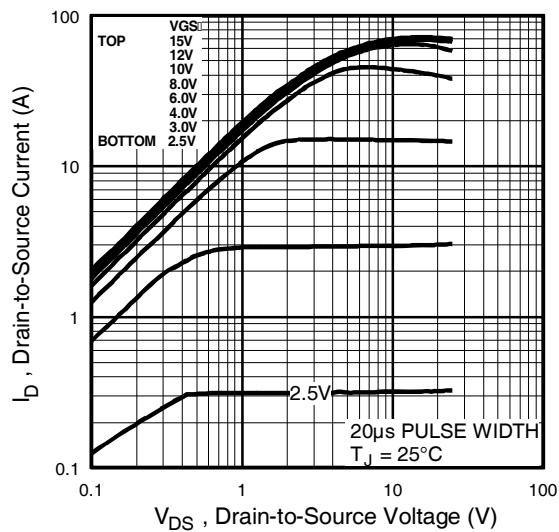


Fig 1. Typical Output Characteristics

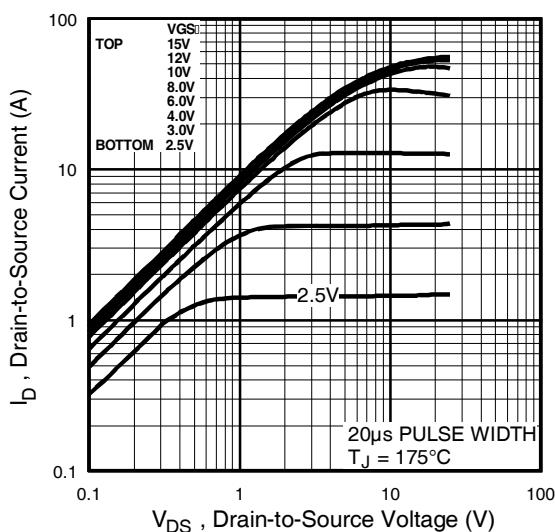


Fig 2. Typical Output Characteristics

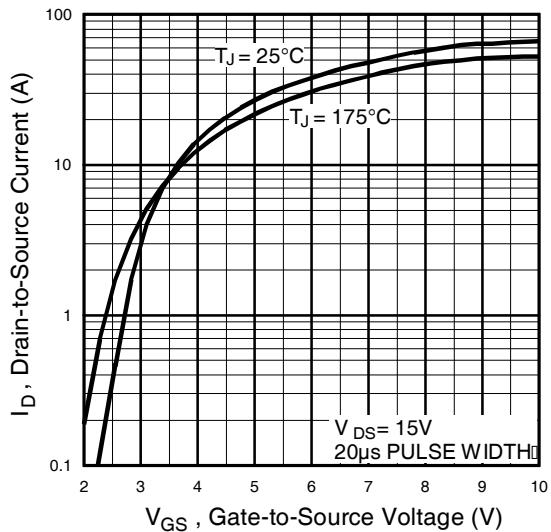


Fig 3. Typical Transfer Characteristics

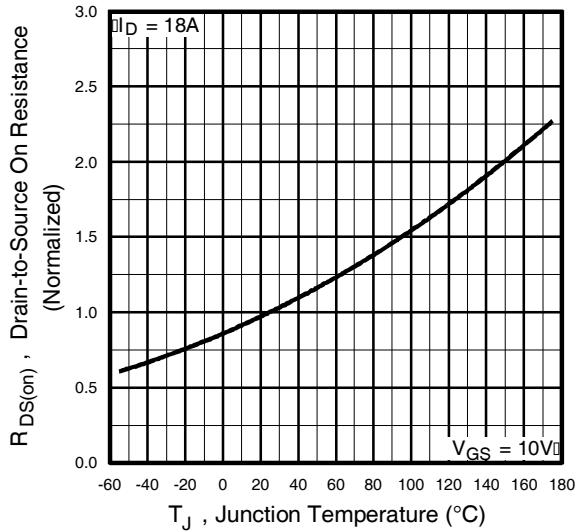
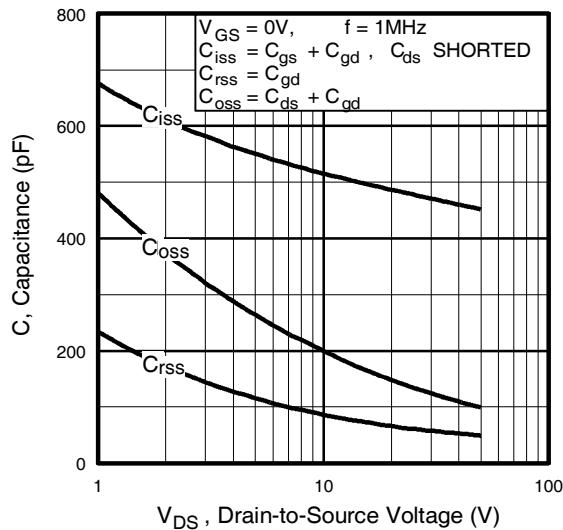
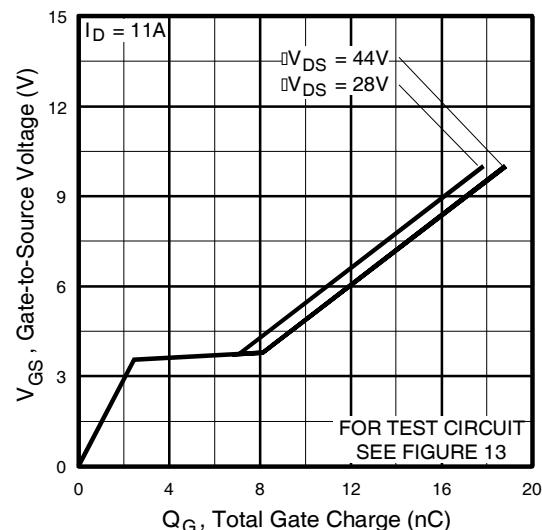


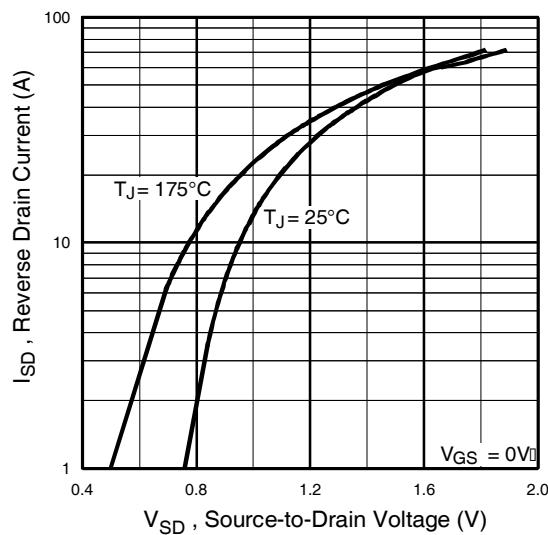
Fig 4. Normalized On-Resistance Vs. Temperature



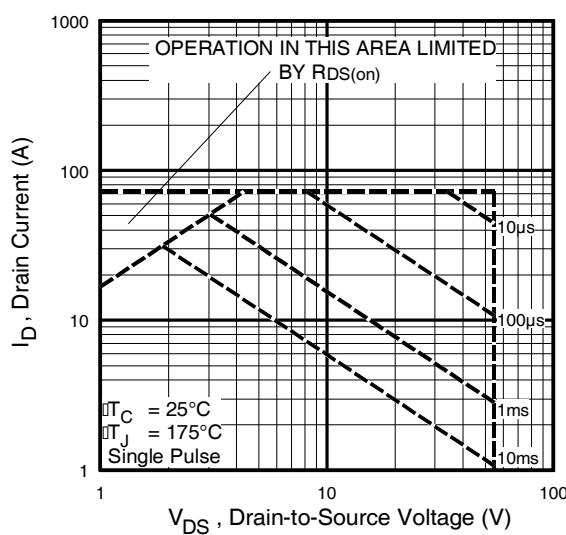
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



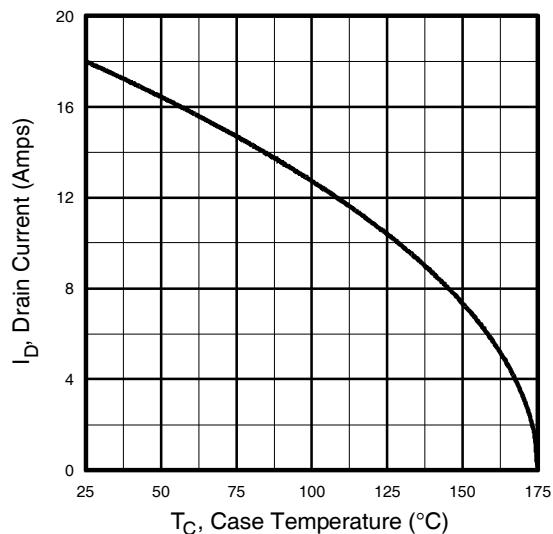
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



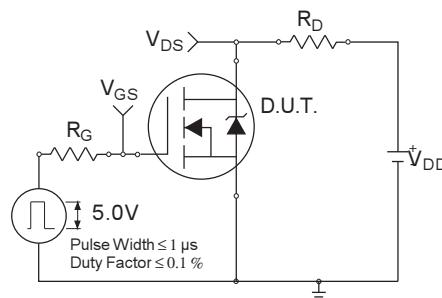
**Fig 7.** Typical Source-Drain Diode



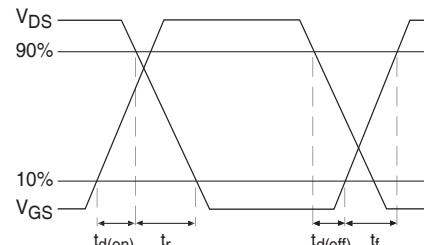
**Fig 8.** Maximum Safe Operating Area



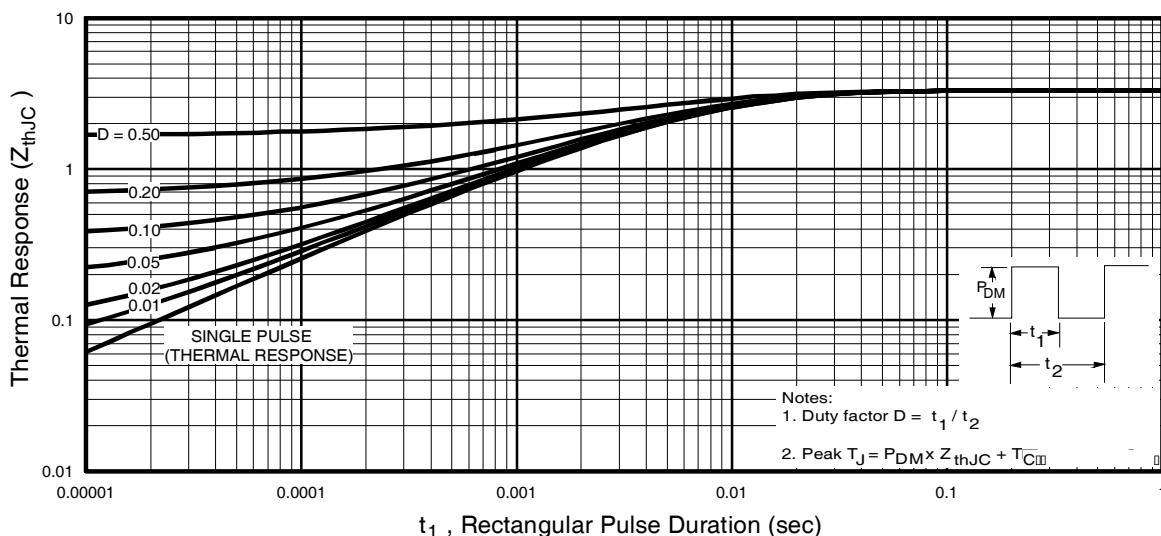
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



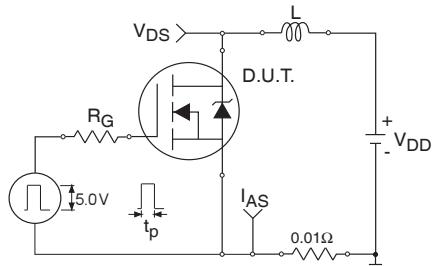
**Fig 10a.** Switching Time Test Circuit



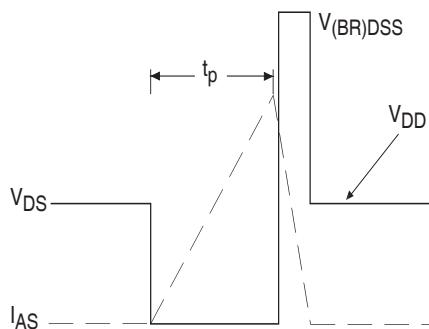
**Fig 10b.** Switching Time Waveforms



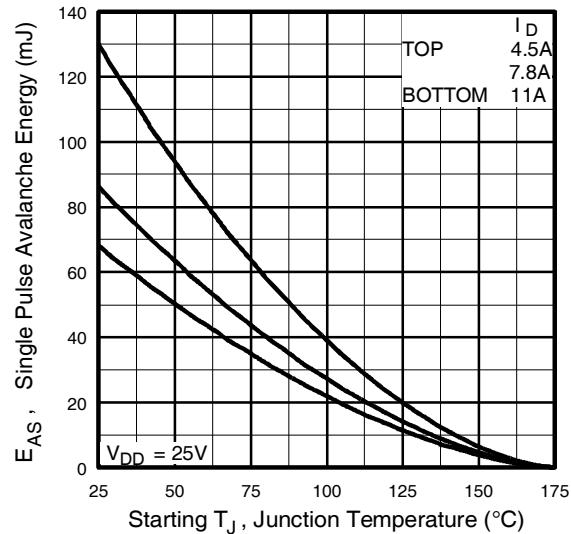
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case



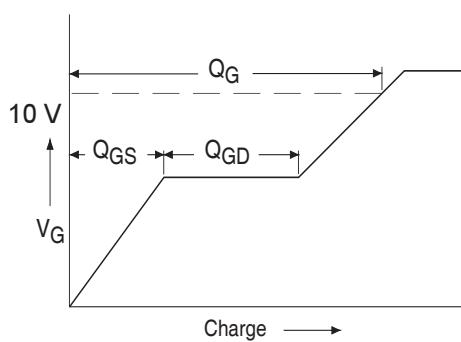
**Fig 12a.** Unclamped Inductive Test Circuit



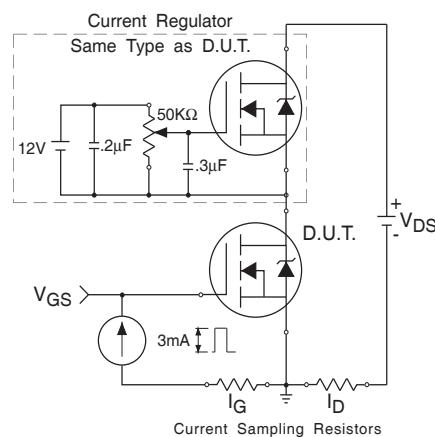
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

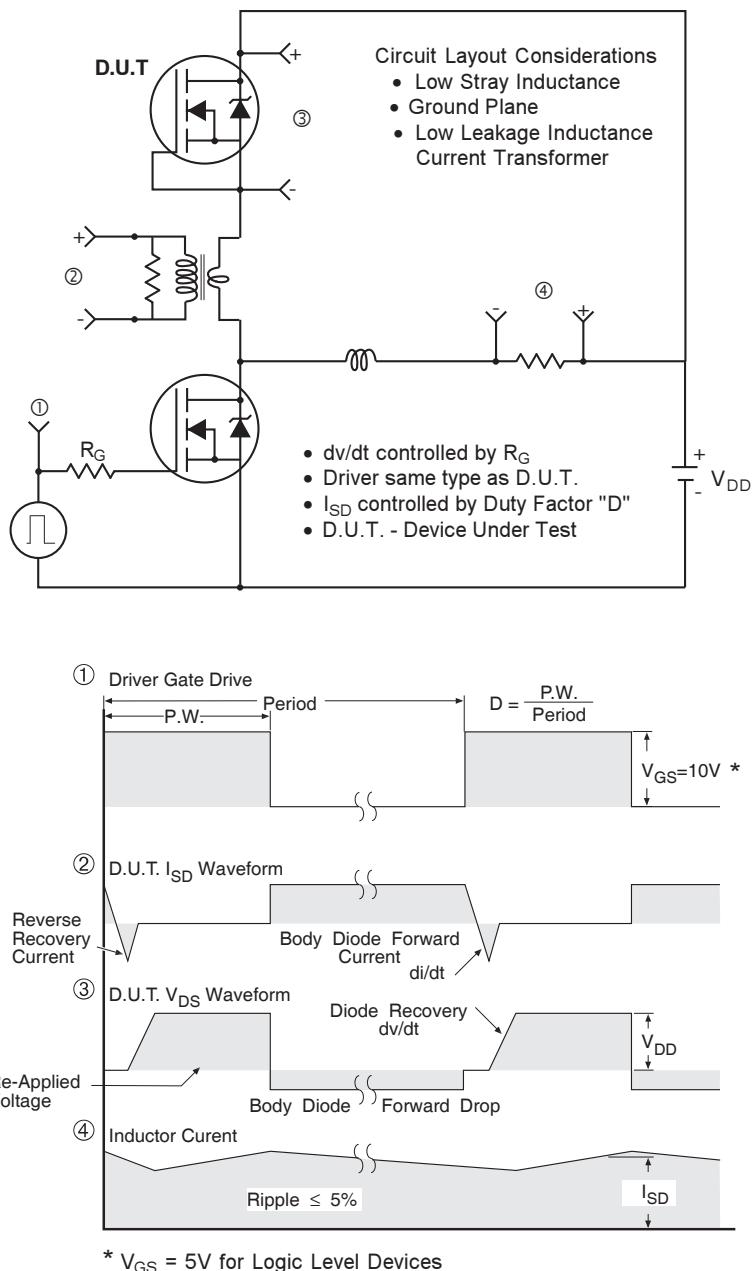


**Fig 13a.** Basic Gate Charge Waveform



**Fig 13b.** Gate Charge Test Circuit

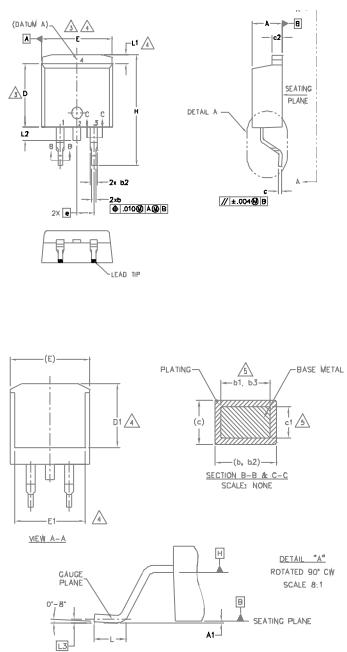
### Peak Diode Recovery dv/dt Test Circuit



**Fig 14. For N-Channel HEXFETS**

## D<sup>2</sup>Pak (TO-263AB) Package Outline

Dimensions are shown in millimeters (inches)



S Y M B O L	DIMENSIONS				N O T E S	
	MILLIMETERS		INCHES			
	MIN.	MAX.	MIN.	MAX.		
A	4.06	4.83	.160	.190		
A1	0.00	0.254	.000	.010		
b	0.51	0.99	.020	.039		
b1	0.51	0.89	.020	.035	5	
b2	1.14	1.78	.045	.070		
b3	1.14	1.73	.045	.068	5	
c	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1.14	1.65	.045	.065		
D	8.38	9.65	.330	.380	3	
D1	6.86	—	.270	—	4	
E	9.65	10.67	.380	.420	3,4	
E1	6.22	—	.245	—	4	
e	2.54	BSC	.100	BSC		
H	14.61	15.88	.575	.625		
L	1.78	2.79	.070	.110		
L1	—	1.68	—	.066		
L2	—	1.78	—	.070		
L3	0.25	BSC	.010	BSC		

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.

4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.

5. DIMENSION b1, b3 AND c1 APPLY TO BASE METAL ONLY.

6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.

7. CONTROLLING DIMENSION: INCH.

8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263AB.

LEAD ASSIGNMENTS

DIODES

1. ANODE (TWO DIE) / OPEN (ONE DIE)
- 2, 4. CATHODE
3. ANODE

HEXFET

1. GATE
- 2, 4. DRAIN
3. SOURCE

IGBT<sub>Si</sub> CoPACK

1. GATE
- 2, 4. COLLECTOR
3. Emitter

## D<sup>2</sup>Pak Part Marking Information

Part Number

AUIRLZ24NS

Date Code

Y= Year

WW= Work Week

A= Automotive, Lead Free

IR Logo

YWWA

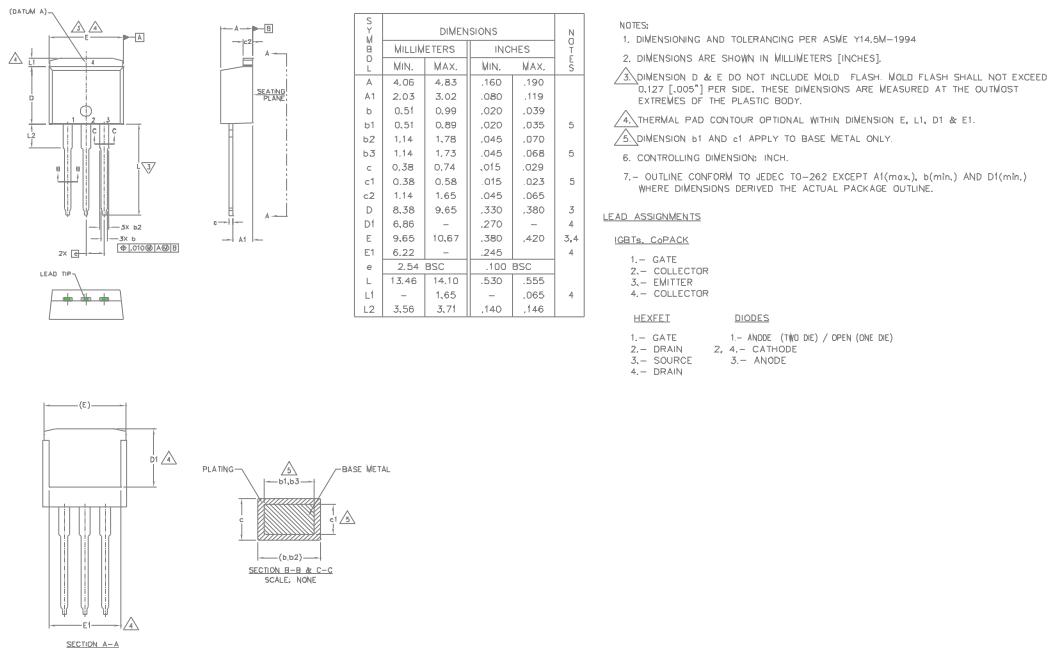
XX ● XX

Lot Code

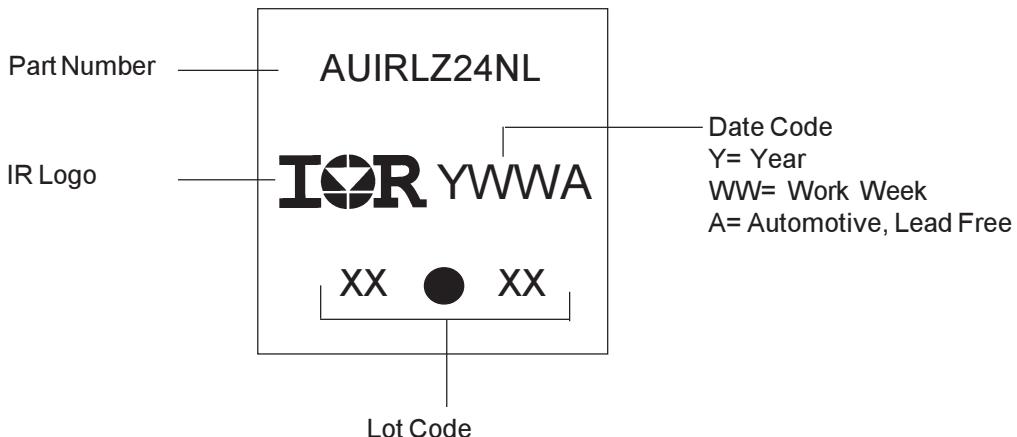
Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## TO-262 Package Outline

Dimensions are shown in millimeters (inches)



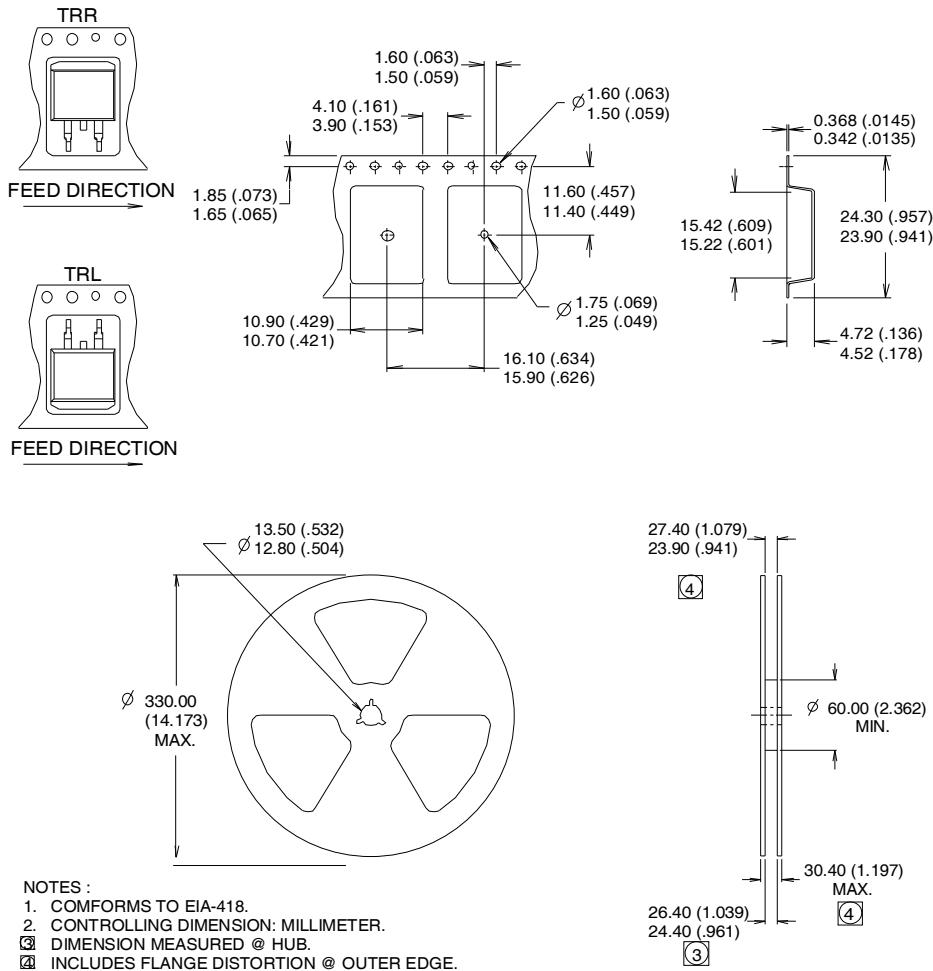
## TO-262 Part Marking Information



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

D<sup>2</sup>Pak Tape & Reel Information

Dimensions are shown in millimeters (inches)



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q101)	
<b>Comments:</b> This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
<b>Moisture Sensitivity Level</b>		3L-D2 PAK	MSL1
<b>ESD</b>	Machine Model	Class M2(+/- 150V) <sup>††</sup> (per AEC-Q101-002)	
	Human Body Model	Class H1A(+/- 500V) <sup>††</sup> (per AEC-Q101-001)	
	Charged Device Model	Class C5(+/- 2000V) <sup>††</sup> (per AEC-Q101-005)	
<b>RoHS Compliant</b>		Yes	

† Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/>

†† Highest passing voltage



AUURLZ24NS/AUURLZ24NL

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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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